



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Grigg et al.

Serial No.: 10/688,354

Filed: October 17, 2003

For: THICK SOLDER MASK FOR CONFINING ENCAPSULANT MATERIAL OVER SELECTED LOCATIONS OF A SUBSTRATE AND ASSEMBLIES INCLUDING THE SOLDER MASK

Confirmation No.: 2306

Examiner: Unknown

Group Art Unit: 2811

Attorney Docket No.: 2269-5216.1US

(99-0507.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

February 26, 2004

Shirley Dougherty
Name (Type/Print)

Signature

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 be considered by the Examiner and made of record. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a). The listed documents were cited by the Office in co-pending application Serial No. 10/201,208, filed on July 22, 2002, and directed to a related invention.

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

U.S. Patent Documents

U.S. Patent No.	Publication Date	<u>Patentee</u>
5,181,984	01/26/1993	Matsumura et al.
6,150,193	11/21/2000	Glenn
6,469,897 B2	10/22/2002	Ho et al.
6,479,887 B1	11/12/2002	Yoon et al.

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits.

Respectfully submitted,

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Date: February 26, 2004

AFN/ps:sd

Enclosures: Form PTO-1449

Copy of documents cited

Document in ProLaw

(2-92)

Sheet 1 of 1

INFORMATION DISCLOSURE CITATION IN AN APPLICATION

(Use several sheets if necessary)

Docket Number (Optional)	
2269-5216.1US	
/QQ_0507 01/HS\	

Application Number 10/688,354

Applicant Grigg et al.

Filing Date October 17, 2003

Group Art Unit 2811

U.S. PATENT DOCUMENTS EXAMINER DOCUMENT FILING DATE IF APPROPRIATE DATE NAME CLASS SUBCLASS INITIAL NUMBER 5,181,984 01/26/1993 Matsumura et al. 6,150,193 11/21/2000 Glenn 6,469,897 B2 10/22/2002 Ho et al. 6,479,887 B1 11/12/2002 Yoon et al. FOREIGN PATENT DOCUMENTS Translation DOCUMENT NUMBER DATE COUNTRY CLASS SUBCLASS YES OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.) **EXAMINER** DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if

not in conformance and not considered. Include copy of this form with next communication to the applicant.